

PATENT ASSIGNMENT COVER SHEET

Electronic Version v1.1
 Stylesheet Version v1.2

EPAS ID: PAT3978327

SUBMISSION TYPE:	NEW ASSIGNMENT	
NATURE OF CONVEYANCE:	RELEASE OF SECURITY INTEREST	
SEQUENCE:	6	
CONVEYING PARTY DATA		
Name		Execution Date
JPMORGAN CHASE BANK, N.A.		06/30/2016
RECEIVING PARTY DATA		
Name:	HEXION INC.	
Street Address:	180 EAST BROAD STREET	
City:	COLUMBUS	
State/Country:	OHIO	
Postal Code:	43215	
PROPERTY NUMBERS Total: 17		
Property Type	Number	
Patent Number:	5962584	
Patent Number:	6013725	
Patent Number:	5962556	
Patent Number:	6534598	
Patent Number:	6548601	
Patent Number:	7129286	
Patent Number:	6984675	
Patent Number:	7060745	
Patent Number:	6825278	
Patent Number:	7189780	
Patent Number:	7101924	
Patent Number:	7186769	
Patent Number:	7173081	
Patent Number:	7671115	
Patent Number:	6080806	
Patent Number:	6469097	
Patent Number:	6391952	
CORRESPONDENCE DATA		

Fax Number:

Correspondence will be sent to the e-mail address first; if that is unsuccessful, it will be sent using a fax number, if provided; if that is unsuccessful, it will be sent via US Mail.

Email: jbraibanti@paulweiss.com

Correspondent Name: JILL C. BRAIBANTI

Address Line 1: PAUL, WEISS, RIFKIND, WHARTON & GARRISON LLP

Address Line 2: 1285 AVENUE OF THE AMERICAS

Address Line 4: NEW YORK, NEW YORK 10019

NAME OF SUBMITTER:	JILL C. BRAIBANTI
---------------------------	-------------------

SIGNATURE:	/Jill C. Braibanti/
-------------------	---------------------

DATE SIGNED:	07/26/2016
---------------------	------------

Total Attachments: 6

source=Project Glenn - Patent Release - JPM 17946-151 (Executed)#page1.tif

source=Project Glenn - Patent Release - JPM 17946-151 (Executed)#page2.tif

source=Project Glenn - Patent Release - JPM 17946-151 (Executed)#page3.tif

source=Project Glenn - Patent Release - JPM 17946-151 (Executed)#page4.tif

source=Project Glenn - Patent Release - JPM 17946-151 (Executed)#page5.tif

source=Project Glenn - Patent Release - JPM 17946-151 (Executed)#page6.tif

RELEASE OF PATENT SECURITY INTEREST

This RELEASE OF PATENT SECURITY INTEREST, dated as of June 30, 2016 (this "Release"), is made by JPMORGAN CHASE BANK, N.A., in its capacity as Administrative Agent and Collateral Agent (the "Releasor"), in favor of HEXION INC., a New Jersey corporation (formerly known as Hexion Specialty Chemicals, Inc.) ("Hexion").

WHEREAS, reference is made to (i) that certain Credit Agreement, dated as of May 31, 2005 (as amended, amended and restated, supplemented or otherwise modified from time to time, the "Credit Agreement"), among Hexion LLC, Hexion, the subsidiaries of Hexion party thereto, the Lenders from time to time party thereto and the Releasor and (ii) that certain Amended and Restated Collateral Agreement, dated as of May 31, 2005 (as amended, supplemented or otherwise modified from time to time, the "Collateral Agreement"), among Hexion LLC, Hexion, each subsidiary of Hexion party thereto and the Releasor as Administrative Agent. Capitalized terms used herein but not defined herein shall have the meanings ascribed to them in the Credit Agreement;

WHEREAS, pursuant to and as set forth in the document recorded with the United States Patent and Trademark Office ("USPTO") on July 14, 2006 in Reel No. 17946, Frame No. 151 (the "Patent Security Agreement" and collectively with the Collateral Agreement, the "Security Agreements"), Hexion granted to the Releasor, its successors and assigns, a security interest in and continuing lien on (referred to in this Release as the "Security Interest") all of its respective right, title and interest in, to or under the Patent Collateral (as defined therein), including the United States patents and patent applications listed on Schedule I hereto (the "Released Patents");

WHEREAS, Hexion has sold or disposed the Released Patents to a person that is not (and is not required to become) a Loan Party and the sale or disposition of the Released Patents is permitted by the Credit Agreement; and

WHEREAS, pursuant to the terms of the Credit Agreement and Collateral Agreement, the Releasor has agreed to terminate and release its Security Interest solely with respect to the Released Patents.

NOW, THEREFORE, for good and valuable consideration, the receipt and sufficiency of which are hereby acknowledged:

1. Release of Lien. The Releasor hereby (i) unconditionally, irrevocably and absolutely terminates, extinguishes, cancels, releases and forever discharges its Security Interest and all of its right, title and interest in or to the Released Patents granted pursuant to the Security Agreements and (ii) terminates the Security Agreements solely with respect to the Released Patents and reassigns to Hexion any and all right, title and interest that the Releasor may have in or to any of the Released Patents. This Release does not release, relinquish, discharge or terminate Releasor's security interest in any other Patent Collateral or asset of Hexion other than the Released Patents set forth on Schedule I hereto.

2. Authorization to Record. The Releasor authorizes and requests that the USPTO and any applicable government officer record this Release with the USPTO.

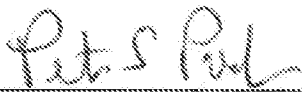
3. Further Assurances. The Releasor agrees to cooperate with Hexion and, solely at the expense of Hexion, to provide Hexion with such information and additional authorization and to execute and deliver to Hexion such additional instruments and to take such action, in each case, as Hexion may reasonably request or as may be desirable to effect and record with the USPTO the release of the Releasor's Security Interest in or to the Released Patents.

4. Governing Law. This Release shall be construed in accordance with and governed by the laws of the State of New York.

[Signature Page Follows]

IN WITNESS WHEREOF, the Releasor has caused this Release of Patent Security Interest to be executed and delivered by its duly authorized officer as of the date first above written.

JPMORGAN CHASE BANK, N.A., in its
capacity as the Administrative Agent and
Collateral Agent

By: 
Name: Peter S. Predun
Title: Executive Director

Schedule I
to
Release of Patent Security Interest

Released Patents

Title	Patent No.	Issue Date	App. No.	App. Date
WATERBORNE LATEX COMPOSITIONS HAVING REACTIVE PENDANT FUNCTIONAL GROUPS AND METHODS OF PREPARING THE SAME	5962584	05-10-99	08/906660	07-08-97
LOW TEMPERATURE CROSSLINKABLE LATEXES FORMED BY IN-SITU GENERATION OF A CROSSLINKABLE FUNCTIONALITY	6013725	11-01-00	08/906659	07-08-97
Functional latexes resistant to hydrolysis	5962556	05-Oct-99	08/861437	21-05-97
FAST-DRY, HIGH SOLIDS COATINGS BASED ON MODIFIED ALKYD RESINS	6534598	18-03-03	10/094136	11-03-02
FAST-DRY HIGH SOLIDS COATINGS BASED ON MODIFIED ALKYD RESINS	6548601	15-04-03	09/596269	16-06-00
Waterborne Acrylic Modified Alkyd Resins	7129286	31-10-06	10/416745	13-05-03
FORMALDEHYDE-FREE BINDER COMPOSITIONS FOR SIMULTANEOUS WARP SIZING AND COLORATION OF FILAMENT YARNS	6984675	10-01-06	10/101038	19-03-02
WATERBORNE ACRYLATE-FUNCTIONALIZED ALKYD COATING COMPOSITIONS	7060745	13-06-06	10/121396	12-04-02

Schedule I-1

PATENT
REEL: 039260 FRAME: 0016

Title	Patent No.	Issue Date	App. No.	App. Date
MODIFIED PRESSURE SENSITIVE ADHESIVE	6825278	30-11-04	10/346350	16-01-03
PROCESSES TO PRODUCE WATER-DISPERSIBLE POLYESTER STABILIZED, ACID-TREATED, FLUOROALKYL COMPOSITIONS	7189780	13-03-07	10/639726	12-08-03
WATER-DISPERSIBLE POLYESTER STABILIZED, ACID-TREATED, FLUOROALKYL COMPOSITIONS	7101924	05-09-06	10/639414	12-08-03
WATER-DISPERSIBLE POLYESTER STABILIZED FLUOROALKYL COMPOSITIONS	7186769	06-03-07	10/639723	12-08-03
PROCESSES TO PRODUCE WATER-DISPERSIBLE POLYESTER STABILIZED FLUOROALKYL COMPOSITIONS	7173081	06-02-07	10/639576	12-08-03
METHOD FOR ENHANCING WATER-REPELLENCY TREATMENT OF MINERAL HYDRAULIC BINDER COMPOSITIONS AND COMPOSITIONS OBTAINABLE BY SAID METHOD AND THEIR USES	7671115	02-03-10	10/538681	10-06-05
WATER-REDISPERSIBLE POWDERS OF FILM-FORMING POLYMERS PREPARED FROM ETHYLENICALLY	6080806	27-06-00	09/101474	08-01-97

Title	Patent No.	Issue Date	App. No.	App. Date
UNSATURATED MONOMERS				
Aqueous polymer dispersions based on unsaturated heterocyclic monomers and use in crosslinking processes	6469097	22-10-02	09/674114	28-04-99
Water-Redispersible Film-Forming Polymer Powders Prepared From Ethylenically Unsaturated monomers and Containing Naphthalenesulphonates	6391952	21-05-02	09/509762	09-07-99

Schedule I-3